

3 PRE AMEND
1-16-02
R. Stokes

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

KOH, PHILIP JOSEPH

Appln. No.: Unknown

Group Art Unit: Unknown

Confirmation No.: Unknown

Examiner: Unknown

Filed: December 03, 2001

For: HIGH FREQUENCY LOW COST PACKAGE FOR SEMICONDUCTOR DEVICES

PRELIMINARY AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

Sir:

Prior to examination, please amend the above-identified application as follows:

IN THE SPECIFICATION:

Amend the specification by inserting before the first line the sentence:

This is a divisional of Application No. 09/752,725 filed January 3, 2001, which claims benefit of Provisional Application No. 60/174,263 filed January 3, 2000; the above noted prior applications are all hereby incorporated by reference.

IN THE CLAIMS:

Please cancel claims 2-22 without prejudice or disclaimer.

Please add the following new claims:

Claims 23-43 are added as new claims.

1. ~~23~~ A method of making an interconnectable package comprising: